

Full Bridge DC Motor Driver ICs SPF7301(under development)

Features

- A DMOS of low ON resistance (0.1Ω typ) is mounted on the high and low side power elements
- Two input signals control the forward/reverse/brake of a DC motor
- Current limit and overcurrent protection circuits
- Low voltage and thermal protection, excess input detecting output and input terminal open protection

Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Ratings	Unit	Remarks
Main power supply voltage	V _B	-0.3 to 36	V	
Input terminal input voltage	V _{IN1} , V _{IN2}	-0.3 to 6	V	
EN terminal voltage	V _{EN}	-0.3 to 12	V	
Disable terminal input voltage	V _{DI}	-0.3 to 6	V	
Output current	I _o	±7	A	
	I _{oPeak}	±15	A	1kHz, Duty<1%, Pulse<10μS
DIAG output current	V _{DIAG}	-0.3 to 6	V	
DIAG inflow current	I _{DIAG}	-3	mA	DIAG terminal sink current
Power dissipation	P _{D1}	39	W	With an infinite heatsink mounted
	P _{D2}	4	W	*1
Junction temperature	T _J	-40 to 150	°C	
Operating temperature	T _{OP}	-40 to 105	°C	
Storage temperature	T _{STG}	-40 to 150	°C	
Thermal resistance (junction to case)	θ _{J-C}	3.2	°C/W	
Thermal resistance (junction to ambient air)	θ _{J-A}	31	°C/W	

Note: *1: With glass epoxy + copper foil board (size 5.0•7.4cm; t: glass epoxy=1.6mm/copper foil=18μm)

Recommended Operation Range

Parameter	Symbol	Ratings	Unit	Remarks
Main power supply voltage	V _B	8 to 18	V	
DI terminal input voltage	V _{DI}	-0.3 to 5.3	V	
Input terminal input voltage	V _{INx}	-0.3 to 5.3	V	
Output current	I _o	±1	A	
DIAG terminal voltage	V _{DIAG}	-0.3 to 5.3	V	
Operating temperature	T _{OP}	-40 to 105	°C	

Electrical Characteristics

(T_J = 30 to 125°C, V_B = 14V, EN = DI = 5V, C_{CP} = 33nF, R_{DIAG} = 20kΩ unless otherwise specified) *2

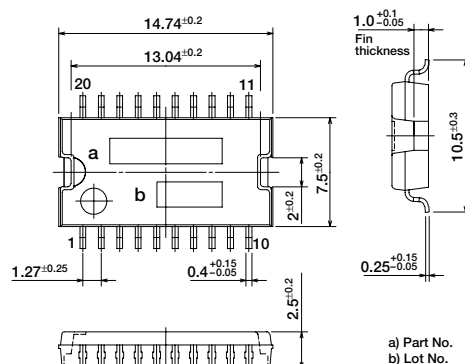
Parameter	Symbol	Ratings			Unit	Conditions
		min	typ	max		
Main power supply current	I _{BB1}		15		mA	
	I _{BB2}			100	μA	For V _{EN} =0V
Low voltage protection operation voltage	V _{UVLOH}	5.0		7.0	V	
	V _{UVLOL}	4.5		6.5	V	
UVLO hysteresis voltage	ΔV _{UVLO}		0.5		V	
Output terminal leak current	I _{leakHS}	-100			μA	
	I _{leakLS}			100	μA	
Output DMOS RDS (ON)	R _{DS(ON)_1H}		100	200	mΩ	
	R _{DS(ON)_2H}		100	200	mΩ	
	R _{DS(ON)_1L}		100	200	mΩ	
	R _{DS(ON)_2L}		100	200	mΩ	
Forward voltage characteristics between output DMOS and DS	V _{F_H1}		1.5		V	I _{o1} = 1A
	V _{F_H2}		1.5		V	I _{o2} = 1A
	V _{F_L1}		1.5		V	I _{o1} = -1A
	V _{F_L2}		1.5		V	I _{o2} = -1A
Overcurrent limiting operation current	I _{ocp1_H1}	4.5	7	10	A	
	I _{ocp1_H2}	4.5	7	10	A	
	I _{ocp1_L1}	4.5	7	10	A	
	I _{ocp1_L2}	4.5	7	10	A	
OPC start current	I _{ocp2_H1}		15		A	
	I _{ocp2_H2}		15		A	
	I _{ocp2_L1}		15		A	
	I _{ocp2_L2}		15		A	
Input terminal voltage	V _{INxH}	2			V	
	V _{INxL}			0.8	V	
Input terminal current	I _{INxH}	-100			μA	V _{DI} = 5V
	I _{INxL}	-100			μA	V _{DI} = 0V
DI terminal voltage	V _{DIH}	2			V	
	V _{DIL}			0.8	V	
DI terminal current	I _{DIxH}	-100			μA	V _{DI} = 5V
	I _{DIxL}	-100			μA	V _{DI} = 0V
EN terminal input voltage	V _{ENTH}	0.8		4	V	
EN terminal input current	I _{ENH}			100	μA	V _{EN} = 5V
	I _{ENL}	-10		10	μA	V _{EN} = 0V
DIAG terminal output voltage	V _{DIAG}			0.8	V	I _{DIAG} = 0.5mA
DIAG terminal output current	I _{DIAG}	1.5			mA	For V _{DIAG} = 1.6V
DIAG terminal leak current	I _{DIAGL}	-10		15	μA	
	T _{don}			20	μS	Time from V _{INxH} to V _{outx} •0.2
	T _{doff}			15	μS	Time from V _{INxL} to V _{outx} •0.8
	T _r			6	μS	Time of V _{outx} from 20% to 80%
	T _f			6	μS	Time of V _{outx} from 80% to 20%
	T _{ddis}			4	μS	Time from D _{lthH} to V _{outx} •0.2
Overvoltage protection operation voltage	V _{ovp}	35	40	45	V	
OVP hysteresis width	ΔV _{ovp}		5		V	
Thermal protection starting temperature	T _{tsd_ON}	151	165		°C	*3
Thermal protection hysteresis width	ΔT _{tsd}		15		°C	*3

Note:

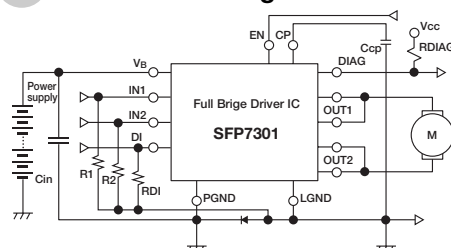
*2: For the electrical characteristics for T_J = -40 to 150°C, the design warranty applies to the above specification values.

*3: Thermal protection starting temperature is 165°C (typ) by design. The above parameters are the design specifications.

External Dimensions (unit: mm)



Standard Circuit Diagram



* Recommended connection parts
Pressure rise capacitor for charge pump circuits (CP to GND) C_p 33nF
DIAG terminal pull-up resistance R_{DIAG}: 20kΩ
Input terminal pull-down resistance R1, R2, RDI, RDL: 10kΩ